

FEATURES

- * HIGH DENSITY SOCKETS FOR IC WITH A PITCH OF 1.778 MM
- * LOW PROFILE DESIGN.
- * SAVING ON PCB REAL SETATE.
- * MANUALLY AND AUTOMATICALLY INSERTABLE.
- * CLOSCED BOTTOM DESIGN TO PREVENT SOLDER WICKING.
- * PROVIDED NEW TYPE FOR FLUX PROTECTION.

TECHNICAL DATA

MATERIAL

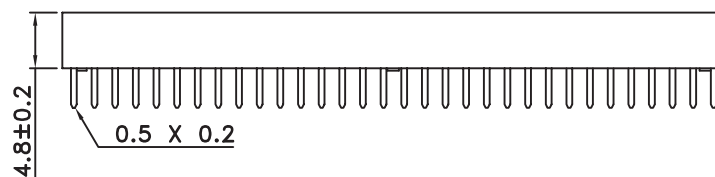
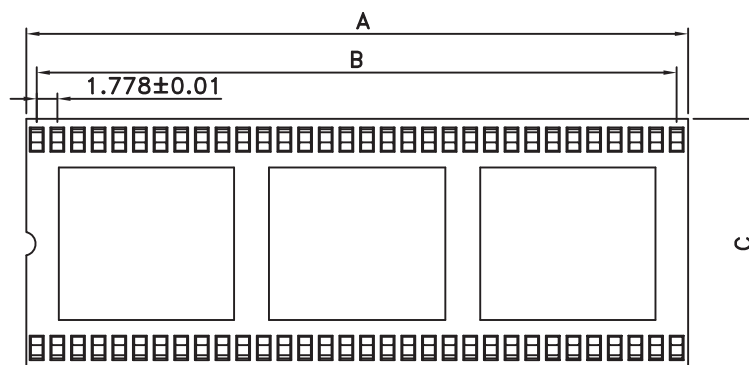
- * CONTACT:PHOSPHOR BRONZE.
- * PLATING:TIN PLATED.
- * INSULATOR:GLASS FILLED POLYESTER P.B.T. (UL-94 V-0)

MACHANICAL

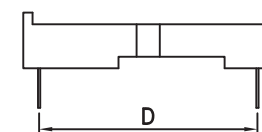
- * OPERATING TEMPERATURES:-55°C~+125°C.
- * INSERTION FORCE: 450 G
- * WITHDRAWAL FORCE: 70 G MIN

ELECTRICAL

- * CURRECT RATING: 1 AMP. MAX.
- * CONTACT RESISTANCE: 20M OMH MIN.
- * WITHSTANDING VOLTAGE: AC 600V/MINUTE.



POSITION	A	B	C	D	SPACE
16	14.22	12.45	10.10	7.62	03
20	17.78	16.00	10.10	7.62	
22	19.56	17.78	10.10	7.62	
24	21.34	19.56	10.10	7.62	
24	21.34	19.56	12.65	10.16	04
28	24.89	23.11	12.65	10.16	
30	26.67	24.89	12.65	10.16	
32	28.45	26.67	12.65	10.16	
40	35.56	33.78	17.70	15.24	06
42	37.34	35.56	17.70	15.24	
48	42.67	40.89	17.70	15.24	
52	46.23	44.45	17.70	15.24	
54	48.01	46.23	17.70	15.24	
56	49.78	48.01	17.70	15.24	
64	56.90	55.12	17.70	15.24	
64	56.90	55.12	21.55	19.05	075



RoHS Compliant

TOLERANCES ARE

MORETHANALL
PCB CONNECTORS
Cable ASSEMBLIES

煜倫股份有限公司

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DRAWING BY CY

CHECKED BY GENIUS

UNIT / mm

SCALE 1 : 1

DATE

SIZE A4

PPOJECTION

X. ±
.X ±
.XX ±
.XXX ±
ANG ±

照片框

ORDER INFORMATION

HIC-Dxx-xx-LF

SERIES | LEADFREE
16-64 WAY

DIP 180°
03:SPACING 7.62mm
04:SPACING 10.16mm
06:SPACING 15.24mm
07:SPACING 19.05mm

DESCRIPTION: HIGH DESITY 1.778MM IC SOCKET